

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32672L9

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High V AC, high temperature (wound)

Typical applications

- Electronic ballasts (resonant circuits)
- SMPS
- High-frequency AC loads
- Pulse circuits

Climatic

- Max. operating temperature: +125 °C
- Climatic category (IEC 60068-1): 55/110/56

Construction

- Dielectric: polypropylene (PP)
- Wound capacitor technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

Features

- Very high AC voltages for all frequency ranges
- Very small dimensions
- High peak voltage for short time periods
- High peak current
- High pulse withstand capability
- RoHS-compatible
- Halogen-free capacitors available on request

Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

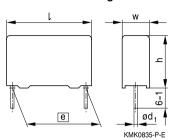
Marking

- Manufacturer's logo
- Lot number, series number
- Rated capacitance (coded)
- Capacitance Tolerance (code letter)
- Rated AC voltage
- Date of manufacture (coded)

Delivery mode

■ Bulk (untaped)

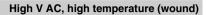
Dimensional drawing



Dimensions in mm

Lead spacing @ ±0.4	Lead diameter d ₁
15	0.8







Overview of available types

Lead spacing	15 mm
Type	B32672L9
Page	4
V _{RMS} (V AC)	900
V _R (V DC)	2000
C _R (nF)	
0.68	
1.0	
1.5	
2.2	
3.3	
4.7	
5.6	
6.8	





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Ordering codes and packing units

V_{RMS}	V_R	C _R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
f≤1 kHz			$w \times h \times l$	(composition see	pack	pcs./	pcs./
V AC	V DC	nF	mm	below)	pcs./MOQ	MOQ	MOQ
900	2000	0.68	$5.0\times10.5\times18.0$	B32672L9681+***	4680	5200	4000
		1.0	$5.0\times10.5\times18.0$	B32672L9102+***	4680	5200	4000
		1.5	$6.0 \times 11.0 \times 18.0$	B32672L9152+***	3840	4400	4000
		2.2	$7.0 \times 12.5 \times 18.0$	B32672L9222+***	3320	3600	4000
		3.3	$8.5 \times 14.5 \times 18.0$	B32672L9332+***	2720	2800	2000
		4.7	$9.0 \times 17.5 \times 18.0$	B32672L9472+***	2560	2800	2000
		5.6	$11.0 \times 18.5 \times 18.0$	B32672L9562+***	_	2200	1000
		6.8	$11.0 \times 18.5 \times 18.0$	B32672L9682+***	_	2200	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series, intermediate capacitance values and closer tolerances on request.

Composition of ordering code

+ = Capacitance tolerance code: *** = Packaging code:

= ±5/6

000 = Untaped (lead length 6 - 1 mm)



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Technical data

Operating temperature range	Max. operating temperature T _{op,max}			+125 °C	
	Upper category temperature T _{max}			+110 °C	
	Lower category temperature T _{min}			−55 °C	
	Rated temperature T _R		+85 °C		
Dissipation factor tan δ (in 10 ⁻³)	at	≤27 nF	27 nF< C _R ≤0.1 μF	0.1 μF < C _R ≤1 μF	>1 μF
at 20 °C	1 kHz	0.8	0.8	0.8	8.0
(upper limit values)	10 kHz	1.0	1.0	1.0	_
	100 kHz	2.0	3.0	_	_
Insulation resistance R _{ins}	> 100 GΩ	•			
at 20 °C, rel. humidity \leq 65%					
(minimum as-delivered values)					
DC test voltage	$1.6 \cdot V_R$, 2 s				
Category voltage V _C	T _A (°C)	DC vol	tage derating	AC voltage deratir	ng
(continuous operation with $\ensuremath{V_{\text{DC}}}$	$T_{\text{A}} \leq 85$	$V_C = V_F$	3	$V_{C,RMS} = V_{RMS}$	
or V_{AC} at $f \le 1$ kHz)	85 <t<sub>A≤110</t<sub>	$V_C = V_F$	$_{R} \cdot (165 - T_{A})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$	
Operating voltage V _{op} for	T _A (°C)	DC vol	tage (max. hours)	AC voltage (max. hours)	
short operating periods	$T_A \le 100$	$V_{op} = 1$.25 · V _C (2000 h)	$V_{op} = 1.0 \cdot V_{C,RMS} (2000 \text{ h})$	
$(V_{DC} \text{ or } V_{AC} \text{ at } f \leq 1 \text{ kHz})$	$100 < T_A \le 125$ $V_{op} = 1.25 \cdot V_C (1000 \text{ h})$		$V_{op} = 1.0 \cdot V_{C,RMS} (1000 h)$		
Damp heat test	56 days/40 °C/93% relative humidity				
Limit values after damp	Capacitance change ΔC/C		≤ 2%		
heat test	Dissipation fa	actor ch	ange Δ tan δ	$\leq 1.0 \cdot 10^{-3}$ (at 1 k	(Hz)
	Insulation res	sistance	R_{ins}	\geq 50 G Ω	
Endurance test conditions	+85 °C / 250	0 V DC	/ 2000 h		
	+85 °C / 112				
	+110 °C / 17				
- · · · · · · · ·	+110 °C / 77	5 V AC	/ 2000 h		
Reliability:	451/24 40	-9/1-\ -4.0	0.5 V 40.00		
Failure rate λ			0.5 · V _R , 40 °C		
Service life t _{SL}	200 000 h at		••		
	For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".			ıres,	
Failure criteria:	тегет то спар	ter Qua	ality, 2 neliability.		
Total failure	Chart disput as appropriate				
Failure due to variation	Short circuit or open circuit				
of parameters	Capacitance change $ \Delta C/C $ > 10% Dissipation factor tan δ > 4 · upper limit values			aluec	
oi parameters	Insulation resistance R _{ins}			< 1500 MΩ	
	Insulation resistance n _{ins} < 1500 Ms2				





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Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/us.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in $V^2/\mu s$.

Note:

The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and ko values

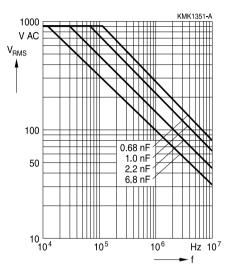
Lead spacing	15 mm	
Туре	B32672L9	
V _{RMS} (V AC)	900	
V _R (V DC)	2000	
C _R (nF)	dV/dt in V/μs	k₀ in V²/μs
0.68	15000	3000000
1.0	15000	3000000
1.5	13500	28000000
2.2	11000	27500000
3.3	10000	27000000
4.7	8200	23500000
5.6	7500	19500000
6.8	6700	18400000



High V AC, high temperature (wound)



Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms $T_A \le 100$ °C) For $T_A > 100$ °C, please refer to "General technical information", section 3.2.3.







High V AC, high temperature (wound)

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

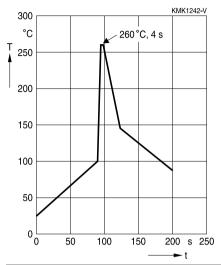
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series	S	Solder bath temperature	Soldering time
MKT	boxed (except 2.5 \times 6.5 \times 7.2 mm)	260 ±5 °C	10 ±1 s
	coated		
	uncoated (lead spacing > 10 mm)		
MFP			
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤ 7.5 mm)		< 4 s
MKT	uncoated (lead spacing ≤ 10 mm)		recommended soldering
	insulated (B32559)		profile for MKT uncoated
			(lead spacing ≤ 10 mm) and
			insulated (B32559)



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Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 $\pm 0.5)$ mm thick, between capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors	
tan δ	As specified in sectional specification	





High V AC, high temperature (wound)

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





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Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



High V AC, high temperature (wound)



Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$lpha_{ extsf{C}}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
$\beta_{ extsf{C}}$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
ΔV/Δt	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
	For the second section of the section of the second section of the section of the second section of the second section of the sectio	Wechselspannung
f_2	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen Wechselspannung
f	Resonant frequency	Resonanzfrequenz
f _r F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
' D	Thermal acceleration factor for diffusion	Diffusion
F⊤	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	

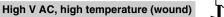




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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
İz	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{o}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_{i}	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_{S}	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \; \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$tan \; \delta_{\scriptscriptstyle P}$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$tan \; \delta_{\text{S}}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Ambient temperature	Umgebungstemperatur
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T_{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer
V_{AC}	AC voltage	Wechselspannung







Symbol	English	German
V _C	Category voltage	Kategoriespannung
$V_{\text{C,RMS}}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_{R}	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß



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